# ROHM EMD9 / UMD9N / IMD9A

General purpose (dual digital transistor)

#### <For DTr1(NPN)>

Parameter	Value
V <sub>CC</sub>	50V
I <sub>C(MAX.)</sub>	100mA
R <sub>1</sub>	10kΩ
R <sub>2</sub>	47kΩ

#### <For DTr2(PNP)>

Parameter	Value
V <sub>CC</sub>	-50V
I <sub>C(MAX.)</sub>	-100mA
R <sub>1</sub>	10kΩ
R <sub>2</sub>	47kΩ

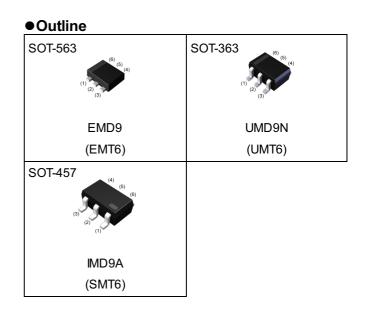
### Features

- 1)DTA114Y and DTC114Y transistor are built-in a EMT or UMT or SMT package.
- 2)Mounting possible with EMT3 or UMT3 or SMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.
- 4)Mounting cost and area can be cut in half.

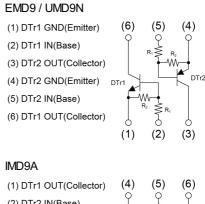
### Application

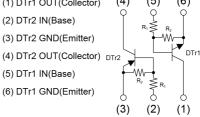
INVERTER, INTERFACE, DRIVER

## Packaging specifications



## Inner circuit





Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMD9	SOT-563 (EMT6)	1616	T2R	180	8	8000	D9
UMD9N	SOT-363 (UMT6)	2021	TR	180	8	3000	D9
IMD9A	SOT-457 (SMT6)	2928	T108	180	8	3000	D9

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Pa	Symbol	DTr1(NPN)	DTr2(PNP)	Unit	
Supply voltage	V <sub>CC</sub>	50	-50	V	
Input voltage	V <sub>IN</sub>	-6 to 40	-40 to 6	V	
Output current	Ι <sub>ο</sub>	70	-70	mA	
Collector current			100	-100	mA
Power dissipation EMD9/ UMD9N IMD9A		P <sub>D</sub> *2*3	150		
		P <sub>D</sub> *2*4	300		mW/Total
Junction temperature			150		°C
Range of storage temperature			-55 to	+150	°C

## •Electrical characteristics (T<sub>a</sub> = 25°C) <For DTr1(NPN)>

Parameter	Sumbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Inputveltage	V <sub>I(off)</sub>	V <sub>CC</sub> = 5V, I <sub>O</sub> = 100µA	-	-	0.3	V
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = 0.3V, I <sub>O</sub> = 1mA	1.4	-	-	
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = 5mA, I <sub>I</sub> = 0.25mA	-	100	300	mV
Input current	I <sub>I</sub>	V <sub>1</sub> = 5V	-	-	880	μA
Output current	I <sub>O(off)</sub>	$V_{CC} = 50V, V_{I} = 0V$	-	-	500	nA
DC current gain	Gı	V <sub>O</sub> = 5V, I <sub>O</sub> = 5mA	68	-	-	-
Input resistance	R <sub>1</sub>	-	7	10	13	kΩ
Resistance ratio	R <sub>2</sub> /R <sub>1</sub>	-	3.7	4.7	5.7	-
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz	-	250	-	MHz

## •Electrical characteristics (T<sub>a</sub> = 25°C) <For DTr2(PNP)>

Deremeter	Cumphed	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input voltage	V <sub>I(off)</sub>	V <sub>CC</sub> = -5V, I <sub>O</sub> = -100µA	-	-	-0.3	V
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = -0.3V, I <sub>O</sub> = -1mA	-1.4	-	-	
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = -5mA, I <sub>I</sub> = -0.25mA	-	-100	-300	mV
Input current	I <sub>I</sub>	V <sub>I</sub> = -5V	-	-	-880	μA
Output current	I <sub>O(off)</sub>	V <sub>CC</sub> = -50V, V <sub>I</sub> = 0V	-	-	-500	nA
DC current gain	Gı	V <sub>O</sub> = -5V, I <sub>O</sub> = -5mA	68	-	-	-
Input resistance	R <sub>1</sub>	-	7	10	13	kΩ
Resistance ratio	$R_2/R_1$	-	3.7	4.7	5.7	-
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA, f = 100MHz	-	250	-	MHz

\*1 Characteristics of built-in transistor.

\*2 Each terminal mounted on a reference land.

\*3 120mW per element must not be exceeded.

\*4 200mW per element must not be exceeded.

## •Electrical characteristic curves(T<sub>a</sub> = 25°C) <For DTR1(NPN)>

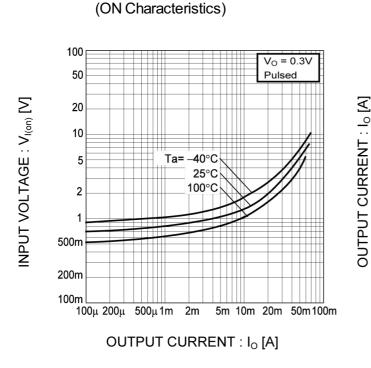


Fig.1 Input Voltage vs. Output Current

Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

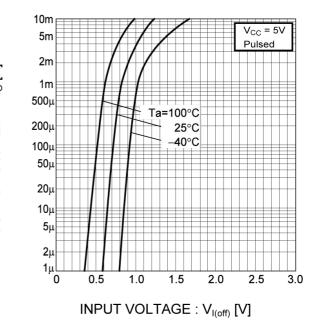


Fig.3 Output Current vs. Output Voltage

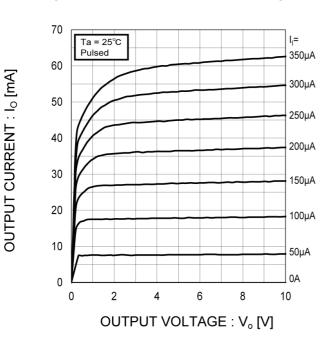
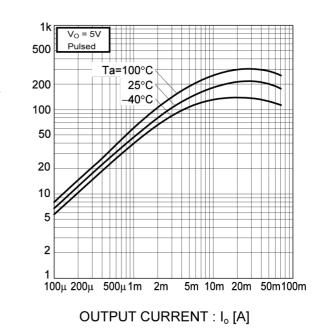


Fig.4 DC Current Gain vs. Output Current

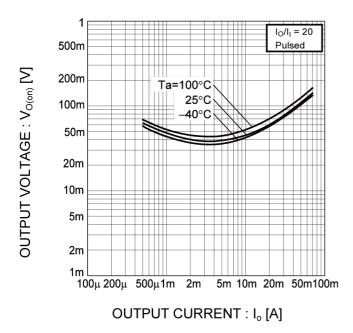


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DC CURRENT GAIN : G

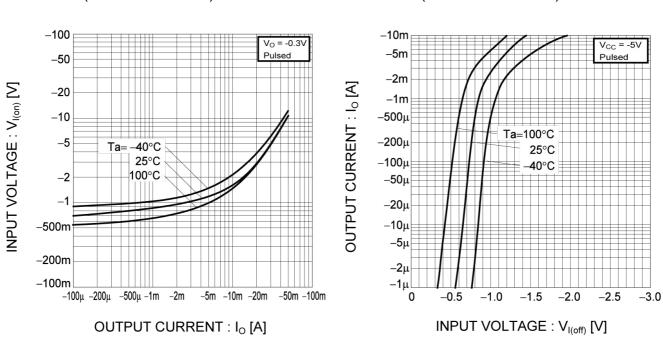
## •Electrical characteristic curves(T<sub>a</sub> = 25°C) <For DTR1(NPN)>







## •Electrical characteristic curves(Ta=25°C) <For DTr2(PNP)>



## Fig.1 Input Voltage vs. Output Current (ON Characteristics)

Fig.4 DC Current Gain vs. Output Current

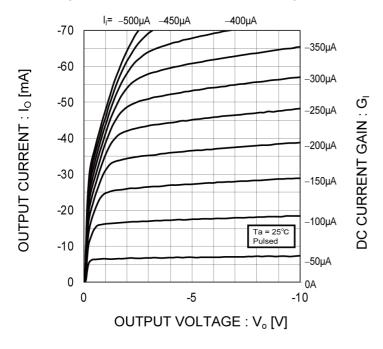
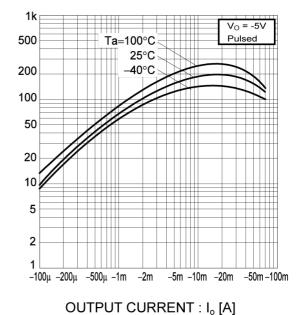
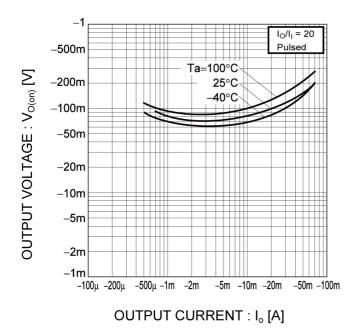


Fig.3 Output Current vs. Output Voltage



## Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

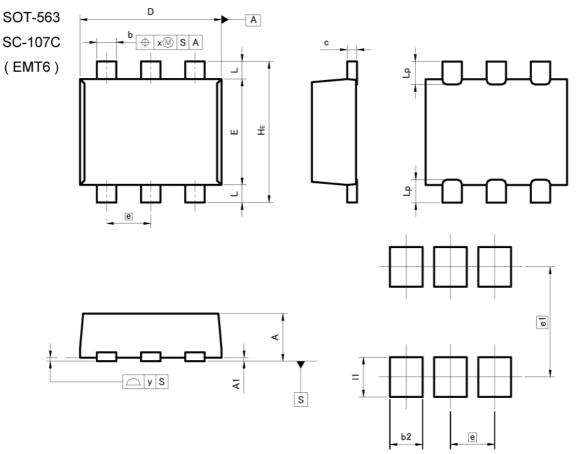








## Dimensions



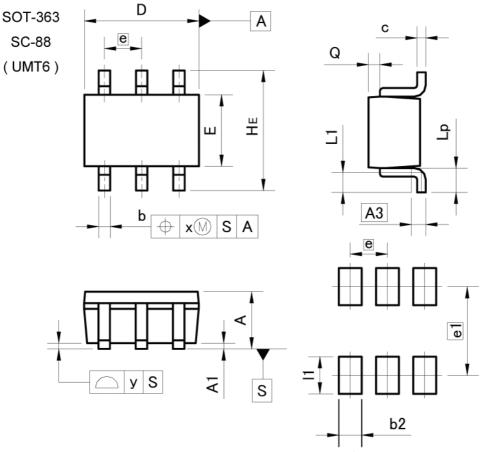
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
A	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
С	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	1.10	1.30	0.043	0.051	
е	0.50		0.020		
HE	1.50	1.70	0.059	0.067	
L	0.10	0.30	0.004	0.012	
Lp	-	0.35	-	0.014	
x	-	0.10	-	0.004	
У	—	0.10	-	0.004	
DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	-	0.37	-	0.015	
e1	1.25		0.049		
- 11	-	0.45	-	0.018	

Dimension in mm/inches



## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

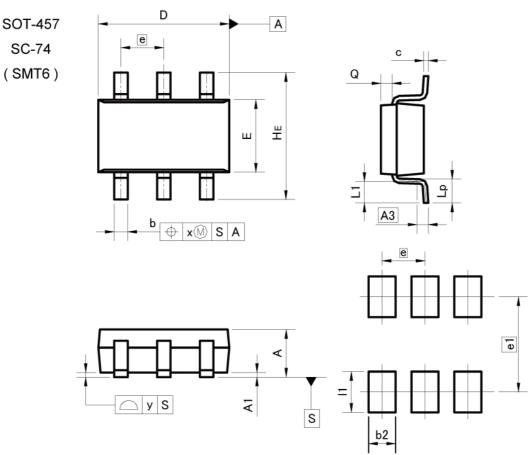
DIM	MILIMETERS		INC	HES		
DIM	MIN	MAX	MIN	MAX		
А	0.80	1.00	0.031	0.039		
A1	0.00	0.10	0.000	0.004		
A3	0.:	25	0.0	10		
b	0.15	0.30	0.006	0.012		
С	0.10	0.20	0.004	0.008		
D	1.90	2.10	0.075	0.083		
E	1.15	1.35	0.045	0.053		
е	0.	0.65		0.026		
HE	2.00	2.20	0.079	0.087		
L1	0.20	0.50	0.008	0.020		
Lp	0.25	0.55	0.010	0.022		
Q	0.10	0.30	0.004	0.012		
x	-	0.10	-	0.004		
У	-	0.10		0.004		
DIM	MILIM	ETERS	INC	HES		
DIN						

DIM MILIME		ETERS	INC	HES
		MAX	MIN	MAX
b2	-	0.40	-	0.016
e1	1.55		0.0	61
1	-	0.65	-	0.026

Dimension in mm/inches



## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	MILIMETERS		HES	
DIM	MIN	MAX	MIN	MAX	
А	1.00	1.30	0.039	0.051	
A1	0.00	0.10	0.000	0.004	
A3	0.	25	0.0	10	
b	0.25	0.40	0.010	0.016	
с	0.09	0.25	0.004	0.010	
D	2.80	3.00	0.110	0.118	
E	1.50	1.80	0.059	0.071	
е	0.	95	0.0	.037	
HE	2.60	3.00	0.102	0.118	
L1	0.30	0.60	0.012	0.024	
Lp	0.40	0.70	0.016	0.028	
Q	0.20	0.30	0.008	0.012	
х	-	0.20	-	0.008	
У	-	0.10	-	0.004	

DIM	MILIM	ETERS	INC	HES
DIM	MIN MAX		MIN	MAX
b2		0.60	-	0.024
e1	2.10		0.0	83
11	-	0.90	<del></del>	0.035

Dimension in mm/inches



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CLASSⅣ		CLASSⅢ	

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  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [C] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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